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FAN48611

Description

The FAN48611 is a low-power boost regulator designed to provide a minimum voltage regulated rail from a standard single-cell Li-Ion battery and advanced battery chemistries. Even below the minimum system battery voltage, the device maintains output voltage regulation. The combination of built-in power transistors, synchronous rectification, and low supply current suit the FAN48611 for battery-powered applications.

The FAN48611 is available in a 9–bump, 0.4 mm pitch, Wafer–Level Chip–Scale Package (WLCSP).

Features

- Input Voltage Range: 2.7 V to 4.8 V
- Output Voltage: 5.25 V
- 350 mA Maximum Output Current
- Internal Synchronous Rectification
- True Load Disconnect
- Short-Circuit Protection
- 9-Bump, 1.215 mm x 1.215 mm, 0.4 mm Pitch, WLCSP
- Three External Components: 2012 1 µH Inductor, 0402 Case Size Input / Output Capacitors
- This Device is Pb-Free, Halide Free and is RoHS Compliant

Applications

- Class-D Audio Amplifier and USB OTG Supply
- Boost for Low-Voltage Li-Ion Batteries
- Smart Phones, Tablets, Portable Devices, and Wearables



WLCSP9 1.215x1.215x0.581 CASE 567QW





10 μF 1 μF FAN48611 1 μF SW PGND EN AGND

Figure 1. Typical Application

ORDERING INFORMATION

See detailed ordering and shipping information on page 10 of this data sheet.

1

BLOCK DIAGRAM



Table 1. Recommended Components

		4	-				
Figure 2. IC Block Diagram							
Component	Description	Vendor	Parameter	Тур.	Unit		
L1	2012, 1.9 A, 0.6 mm Max. Height	PIXC20120F1R0MDR		1	μH		
			DCR (Series R)	175	mΩ		
CIN	20%, 6.3 V, X5R, 0402	C1005X5R0J106M050BC TDK	VC	10	μF		
COUT	20%, 6.3 V, X5R, 0402	C1005X5R0J106M050BC TDK	c v v	10	μF		



PIN DEFINITIONS

Pin #	Name	Description
A1, A2	VOUT	Output Voltage. This pin is the output voltage terminal; connect directly to C _{OUT} .
A3	VIN	Input Voltage. Connect to the Li-Ion battery input power source and the bias supply for the gate drivers.
B1, B2	SW	Switching Node. Connect to inductor.
B3	EN	<i>Enable</i> . When this pin is HIGH, the circuit is enabled. Connection to a logic voltage of 1.8 V and delivery voltage after UVLO typical voltage of 2.2 V is recommended.
C1, C2	PGND	<i>Power Ground</i> . This is the power return for the IC. C _{OUT} capacitor should be returned with the shortest path possible to these pins.
C3	AGND	Analog Ground. This is the signal ground reference for the IC. All voltage levels are measured with respect to this pin. Connect to PGND at a single point.

ABSOLUTE MAXIMUM RATINGS

Symbol	Para	Parameter		Max	Unit
V _{IN}	Voltage on VIN Pin		-0.3	6.0	V
V _{OUT}	Voltage on VOUT Pin		-0.3	6.0	V
V _{SW}	Voltage on SW Node DC		-0.3	6.0	V
		Transient: 10 ns, 3 MHz	-1.0	8.0	
V _{CC}	Voltage on Other Pins		-0.3	6.0 (Note 1)	V
ESD	Electrostatic Discharge Protection Level	Human Body Model, ANSI/ESDA/JEDEC JS-001-2012	2		kV
		Charged Device Model per JESD22-C101		2	
TJ	Junction Temperature		-40	+150	°C
T _{STG}	Storage Temperature		-65	+150	°C
ΤL	Lead Soldering Temperature, 10 Seconds		_	+260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality EN DES should not be assumed, damage may occur and reliability may be affected.

1. Lesser of 6.0 V or V_{IN} + 0.3 V.

RECOMMENDED OPERATING CONDITIONS

Symbol		Parameter		Min	Мах	Unit
V _{IN}	Supply Voltage		. Or	2.7	4.8	V
I _{OUT}	Maximum Output Current			350	_	mA
T _A	Ambient Temperature		IDE ON	-40	+85	°C
TJ	Junction Temperature		KR IK P	-40	+125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

THERMAL PROPERTIES (Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four- layer 2s2p boards with vias in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature, $T_{J(max)}$, at a given ambient temperature, T_{A} .)

Symbol	Characteristic	Value	Unit
Θ_{JA}	Junction-to-Ambient Thermal Resistance	50	°C/W
4	HIS DEVIC PLEESE		

ELECTRICAL CHARACTERISTICS (Recommended operating conditions, unless otherwise noted, circuit per Figure 1, VOUT= 5.25 V, VIN = 2.7 V to 4.8 V, and TA = -40°C to 85°C. Typical values are given VIN = 3.7 V and TA = 25°C.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
POWER SUP	› ›PLY	•				
Ι _Q	V _{IN} Quiescent Current	$V_{IN} = 3.7 \text{ V}, \text{ I}_{OUT} = 0, \text{ EN} = V_{IN}$	-	90	140	μA
		Shutdown: EN = 0, V_{IN} = 3.7 V, V_{OUT} = 0 V	-	2.7	10.0	
V _{UVLO}	Under-Voltage Lockout	V _{IN} Rising	-	2.2	2.3	V
V _{UVLO_HYS}	Under-Voltage Lockout Hysteresis		-	150	-	mV
NPUTS						
VIH	Enable HIGH Voltage		1.2	-	-	V
VIL	Enable LOW Voltage		-	-	0.4	V
I _{PD}	Current Sink Pull-Down	EN Pin, Logic HIGH	_	100		nA
R _{LOW}	Low-State Active Pull-Down	EN Pin, Logic LOW	200	300	400	kΩ
OUTPUTS					- Gr	
V _{REG}	Output Voltage Accuracy DC (Note 2)	Referred to V _{OUT}	-2	-<	3 4	%
I _{LK_OUT}	VIN-to-VOUT Leakage Current	V _{OUT} = 0, EN = 0, V _{IN} = 2.7 V	-	1 Pr	1	μA
I _{LK}	VOUT-to-VIN Reverse Leakage Current	$V_{OUT} = 5.3 \text{ V}, \text{ EN} = 0, V_{IN} = 2.7 \text{ V}$	NE	- 1	3.5	μA
V _{RIPPLE}	Output Ripple (Note 3)	0 mA to 300 mA	<u>in-</u>	30	-	mV
V _{TRLOAD}	Load Transient (Note 3)	I_{LOAD} = 0 mA <> 120 mA, t_R = t_F = 1 μ s	. 6-	±30	-	
		$I_{LOAD} = 0 \text{ mA} <> 285 \text{ mA}, t_R = t_F = 8 \ \mu s$	An	±90	-	mV
V _{TRLINE}	Line Transient (Note 3)	V_{IN} = 3.2 V <> 3.9 V, I _{LOAD} = 120 mA, t_R = t_F = 7 μ s	5/14.	±50	-	mV
η	Efficiency (Note 3)	$V_{IN} = 3 V_r + LOAD = 5 mA$	-	85	-	%
		V _{IN} = 3 V, I _{LOAD} = 200 mA	-	90	-	
		V _{IN} = 3.6 V, I _{LOAD} = 200 mA	-	91	-	
		V _{IN} = 3.6 V, I _{LOAD} = 300 mA	-	92	-	
FIMING	ST ST	FTAI				
f _{SW}	Switching Frequency	V _{IN} = 3.6 V, V _{OUT} = 5.25 V, I _{LOAD} = 300 mA	2.0	2.5	3.0	MHz
t _{SS}	Soft-Start EN HIGH to Regulation (Note 3)	V_{IN} = 3.0 V, V_{OUT} = 5.25 V, I_{LOAD} = 0 mA, C_{OUT} = 3 x 10 μF	-	1000	-	μs
I _{SS}	Input Peak Current		_	90	200	mA
t _{RST}	FAULT Restart Timer (Note 3)		_	20	-	ms
POWER STA	GE					
R _{DS(ON)N}	N-Channel Boost Switch R _{DS(ON)}	V _{IN} = 3.6 V, V _{OUT} = 5.25 V	-	80	130	mΩ
R _{DS(ON)P}	P-Channel Sync. Rectifier R _{DS(ON)}	V _{IN} = 3.6 V, V _{OUT} = 5.25 V	-	65	115	mΩ
I_{V_LIM}	Boost Valley Current Limit	V _{OUT} = 5.25 V	-	750	-	mA
$I_{V_LIM_SS}$	Boost Soft-Start Valley Current Limit	V _{IN} < V _{OUT} < V _{OUT_TARGET}	-	375	-	А
T _{150T}	Over-Temperature Protection (OTP)		-	150	-	°C
T _{150H}	OTP Hysteresis		-	20	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. DC I_{LOAD} from 0 to 0.35 A. V_{OUT} measured from mid-point of output voltage ripple. Effective capacitance of $C_{OUT} \ge 6 \mu F$. 3. Guaranteed by design and characterization; not tested in production.

TYPICAL PERFORMANCE CHARACTERISTICS

(Unless otherwise specified; V_{IN} = 3.6 V, V_{OUT} = 5.25 V, T_A = 25°C, and circuit according to Figure 1.)













Figure 6. Shutdown Current vs. Load Voltage and



Figure 8. Efficiency vs. Load Current and Temperature





TYPICAL PERFORMANCE CHARACTERISTICS

(Unless otherwise specified; V_{IN} = 3.6 V, V_{OUT} = 5.25 V, T_A = 25°C, and circuit and components according to Figure 1.)



TYPICAL PERFORMANCE CHARACTERISTICS

(Unless otherwise specified; V_{IN} = 3.6 V, V_{OUT} = 5.25 V, T_A = 25°C, and circuit and components according to Figure 1.)



FUNCTIONAL DESCRIPTION

FAN48611 is a synchronous boost regulator, typically operating at 2.5 MHz in Continuous Conduction Mode (CCM), which occurs at moderate to heavy load current and low V_{IN} voltage.

Table 2. OPERATING MODES

Mode	Description	Invoked When:
LIN	Linear Startup	V _{IN} > V _{OUT}
SS	Boost Soft-Start	V _{IN} < V _{OUT} < V _{OUT(TARGET)}
BST	Boost Mode	$V_{OUT} = V_{OUT(TARGET)}$

Boost Mode Regulation

The current-mode modulator achieves excellent transient response and smooth transitions between CCM and DCM operation. During CCM operation, the device maintains a switching frequency of about 2.5 MHz. In light-load operation (DCM), frequency is naturally reduced to maintain high efficiency.

Startup and Shutdown

When EN is LOW, all bias circuits are off and the regulator enters Shutdown Mode. During shutdown, current flow is prevented from VIN to VOUT, as well as reverse flow from VOUT to VIN. It is recommended to keep load current draw below 50 mA until the device successfully executes startup. Table 3 describes the startup sequence.

Table 3. BOOST STARTUP SEQUENCE

Start Mode	Entry	Exit	End Mode	Timeout (μs)
LIN1	V _{IN} > V _{UVLO} , EN=1	V _{OUT} > V _{IN} -300 mV	ss	
		TIMEOUT	LIN2	512
LIN2	LIN1 Exit	V _{OUT} > V _{IN} -300 mV	SS	-
	SV	TIMEOUT	FAULT	1024
SS	LIN1 or LIN2 Exit	V _{OUT} = V _{OUT(TARGET)}	BST	_
		OVERLOAD TIMEOUT	FAULT	64

LIN Mode

When EN is HIGH and $V_{IN} > V_{UVLO}$, the regulator attempts to bring VOUT within 300 mV of V_{IN} using the

internal fixed-current source from VIN (Q2). The current is limited to the I_{ss} set point, which is typically 90 mA. The linear charging current is limited to a maximum of 200 mA to prevent any "brownout" situations where the system voltage drops too low.

During LIN1 Mode, if V_{OUT} reaches V_{IN} -300 mV, SS Mode is initiated. Otherwise, LIN1 Mode expires after 512 μ s and LIN2 Mode is entered.

In LIN2 Mode, the current source is equal to LIN1 current source I_{ss}, typically 90 mA. If V_{OUT} fails to reach V_{IN}-300 mV after 1024 μ s, a fault condition is declared and the device waits 20 ms (t_{RST}) to attempt an automatic restart.

Soft-Start (SS) Mode

Upon the successful completion of LIN Mode (VOUT \geq V_{IN}-300 mV), the regulator begins switching with boost pulses current limited to 50% of nominal level.

During SS Mode, if VOUT fails to reach regulation during the SS ramp sequence for more than 64 μ s, a fault is declared. If a large C_{OUT} is used, the reference is automatically stepped slower to avoid excessive input current draw.

Boost (BST) Mode

This is a normal operating mode of the regulator.

Fault State

The regulator enters Fault State under any of the following conditions:

- V_{OUT} fails to achieve the voltage required to advance from LIN Mode to SS Mode.
- V_{OUT} fails to achieve the voltage required to advance from SS Mode to BST Mode.
- Boost current limit triggers for 2 ms during BST Mode.
- V_{IN} V_{OUT} > 300 mV; this fault can occur only after successful completion of the soft–start sequence.
- $V_{IN} < V_{UVLO}$.

Once a fault is triggered, the regulator stops switching and presents a high–impedance path between VIN and VOUT. After 20 ms, automatic restart is attempted.

Over-Temperature

The regulator shuts down if the die temperature exceeds 150°C. Restart occurs when the IC has cooled by approximately 20°C.

APPLICATION INFORMATION

Output Capacitance (COUT)

The effective capacitance (C_{EFF} (Note 4)) of small, high-value ceramic capacitors decreases as the bias voltage increases, as illustrated in Figure 18.





FAN48611 is guaranteed for stable operation with the minimum value of C_{EFF} ($C_{EFF(MIN)}$) outlined in Table 4.

Table 4. MINIMUM CEFF REQUIRED FOR STABILITY

Ор	Operating Conditions						
V _{OUT} (V)	V _{IN} (V)	I _{LOAD} (mA)	C _{EFF(MIN)} (μF)				
5.25	2.7 to 4.8	0 to 350	6.0				

4. C_{EFF} varies by manufacturer, capacitor material, and case size.

Inductor Selection

Recommended nominal inductance value is 1 µH.

The FAN48611 employs valley-current limiting, so peak inductor current can reach 1.2 A for a short duration during overload conditions. Saturation causes the inductor current ripple to increase under high loading, as only the valley of the inductor current ripple is controlled.

Startup

Input current limiting is active during soft-start, which limits the current available to charge C_{OUT} and any additional capacitance on the V_{OUT} line. If the output fails to achieve regulation within the limits described in the Soft-Start section above, a fault occurs, causing the circuit to shut down. It waits about 20 ms before attempting a restart. If the total combined output capacitance is very high, the circuit may not start on the first attempt, but eventually achieves regulation if no load is present. If a high current load and high capacitance are both present during soft-start, the circuit may fail to achieve regulation and continually attempt soft-start, only to have the output capacitance discharged by the load when in Fault State.

Output Voltage Ripple

Output voltage ripple is inversely proportional to C_{OUT} . During t_{ON} , when the boost switch is on, all load current is supplied by C_{OUT} .

$$V_{\text{RIPPLE}(P-P)} = t_{\text{ON}} \cdot \frac{I_{\text{LOAD}}}{C_{\text{OUT}}}$$
 (eq. 1)

and

$$t_{ON} = t_{SW} \cdot D = t_{SW} \cdot \left(1 - \frac{V_{IN}}{V_{OUT}}\right)$$
 (eq. 2)

therefore:

$$V_{\text{RIPPLE}(P-P)} = t_{\text{SW}} \cdot \left(1 - \frac{V_{\text{IN}}}{V_{\text{OUT}}}\right) \cdot \frac{I_{\text{LOAD}}}{C_{\text{OUT}}}$$
(eq. 3)
$$t_{\text{SW}} = \frac{1}{f_{\text{SW}}}$$
(eq. 4)

The maximum V_{RIPPLE} occurs when V_{IN} is minimum and I_{LOAD} is maximum. For better ripple performance, more output capacitance can be added.

Layout Recommendations

The layout recommendations below highlight various top-copper pours by using different colors.

To minimize spikes at VOUT, C_{OUT} must be placed as close as possible to PGND and VOUT, as shown below.

For best thermal performance, maximize the pour area for all planes other than SW. The ground pour, especially, should fill all available PCB surface area and be tied to internal layers with a cluster of thermal vias.



Figure 19. Layout Recommendation

ORDERING INFORMATION

Part Number	Device Marking	V _{OUT}	Operating Temperature	Package	Packing Method [†]
FAN48611UC53X	КН	5.25 V	–40 to 85°C	WLCSP9 1.215x1.215x0.581 (Pb-Free and Halide Free)	3000 / Tape and Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

The table below pertains to the Package Information on the following page.

Table 5. PRODUCT-SPECIFIC PACKAGE DIMENSIONS

D	E	x	Y
1.215 ±0.030 mm	1.215 ±0.030 mm	0.2075 mm	0.2075 mm
THIS DEVIC	REPRESENTATION IN THE PLEASENT AT THE PRESENT AT THE PRESENT AT THE PLEASENT A	-NDED FOR	EN DESIGN ATION

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